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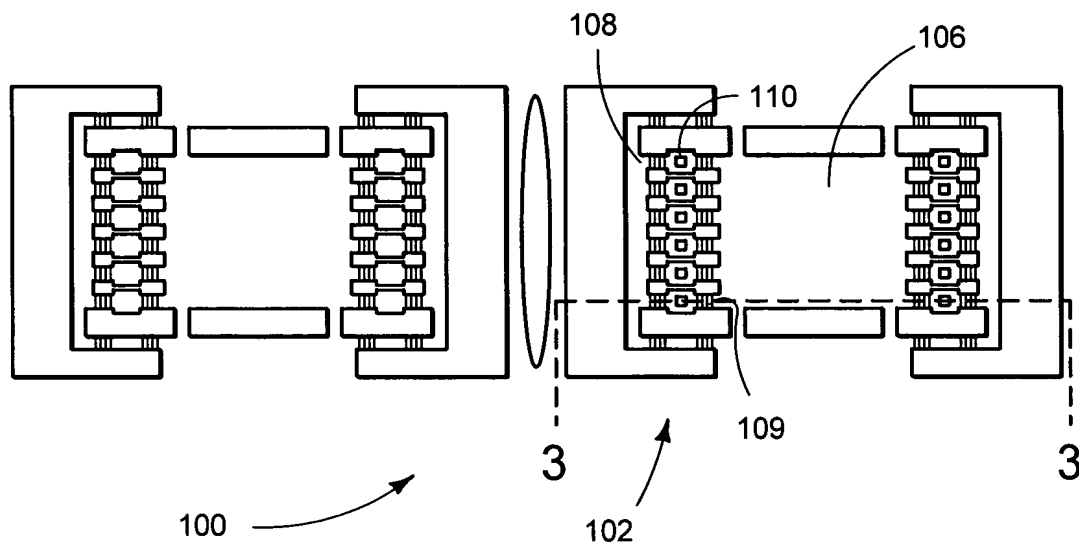


FIG. 1

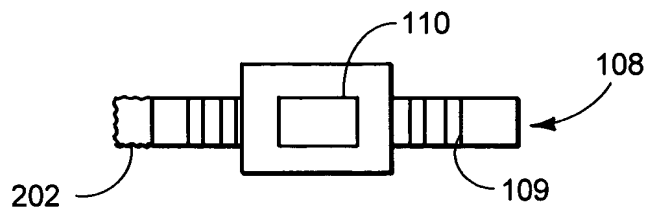


FIG. 2



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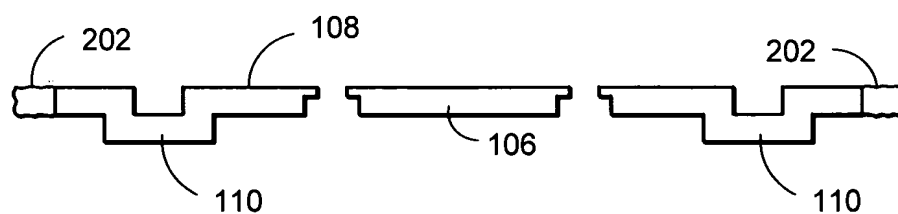


FIG. 3A

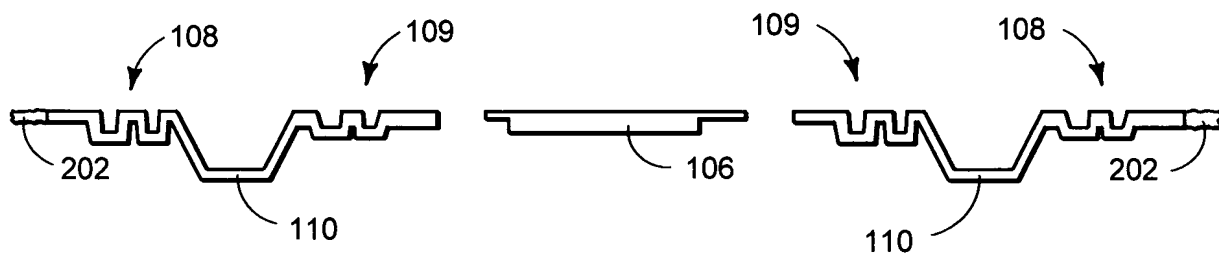


FIG. 3B

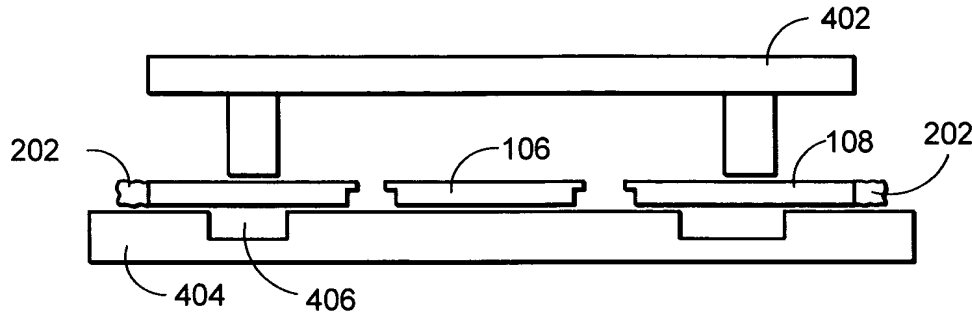


FIG. 4A

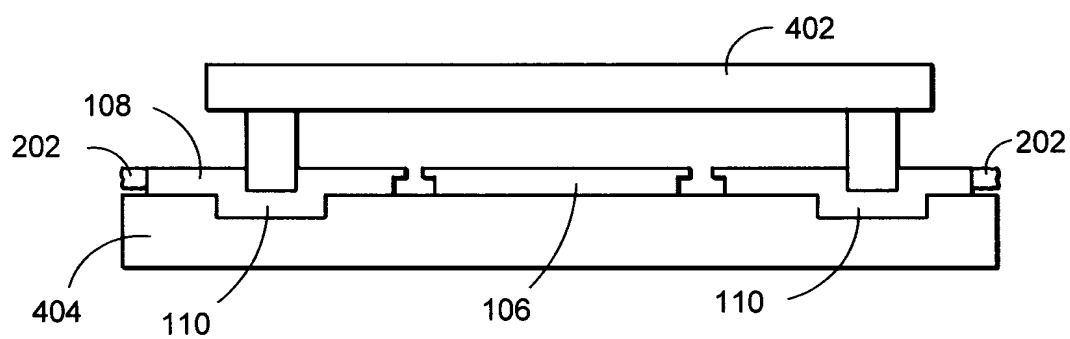


FIG. 4B

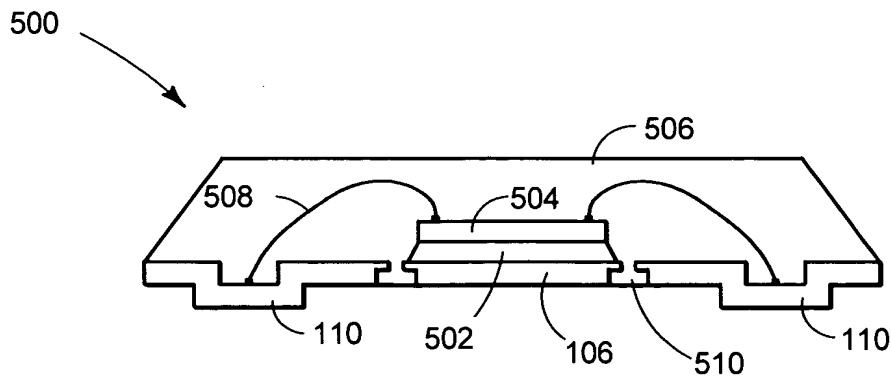


FIG. 5



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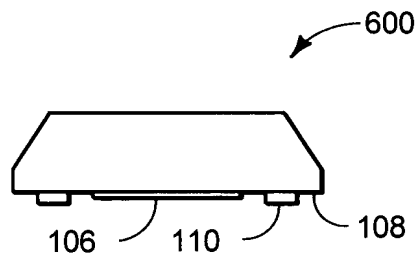


FIG. 6A

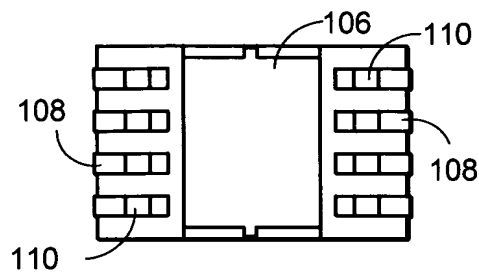


FIG. 6B

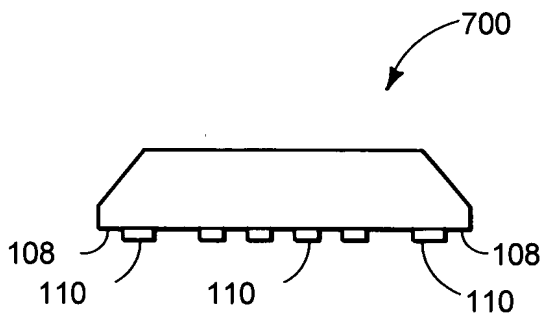


FIG. 7A

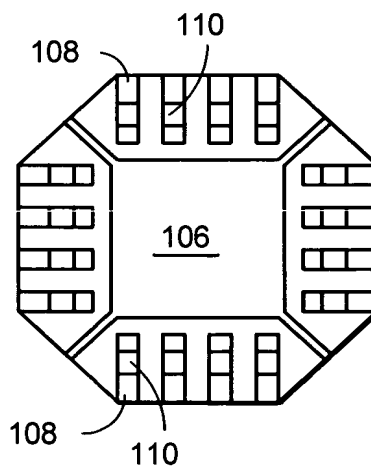


FIG. 7B



TITLE: BUMP CHIP LEAD FRAME AND PACKAGE
INVENTOR: Hung V. Ngo
SERIAL NO.: 09/736462 - DOCKET NO.: ONSSC0853AM
REPLACEMENT SHEET

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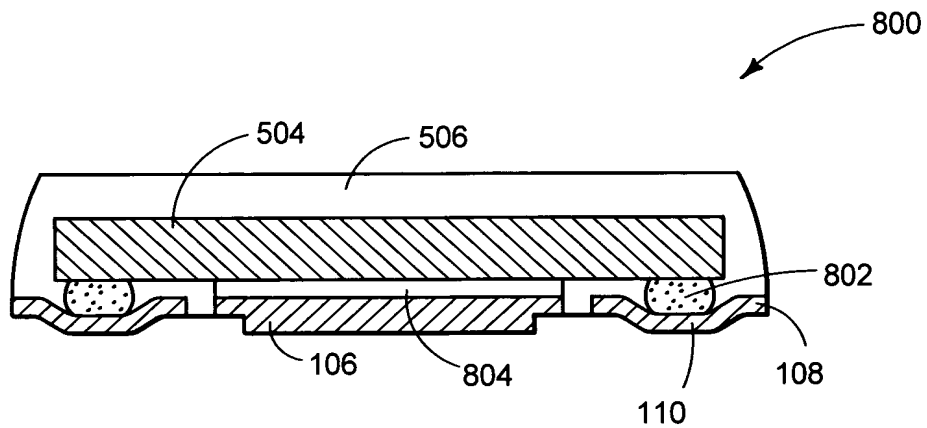


FIG. 8